

TEST RESEARCH, INC. (TRI)

**Come see us at
1H38 (Hall 1) !**

**德律科技股份有限公司
欢迎莅临1H38 (1号馆)
参观**



**3D AOI
TR7700Q**



**NEPCON
China 2016**



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**APRIL 26~28, 2016
HALL 1&2,
SHANGHAI WORLD
EXPO EXHIBITION &
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ORGANISED BY



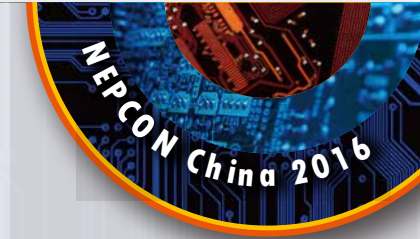
www.nepconacrosschina.com April 26, 09:30~16:30 April 27, 09:00~16:30
April 28, 09:00~16:00

TEST RESEARCH, INC. (TRI)

Test Research, Inc. (TRI) offers a complete One Stop Solution with integrated software (YMS 4.0) to support Industry 4.0. TRI provides high-precision and high-resolution PCBA inspection solutions, including 3D Solder Paste Inspection (3D SPI), 3D Automated Optical Inspection (3D AOI), 3D Automated X-ray Inspection (3D AXI, upgradable to Computed Tomography), Manufacturing Defect Analyzers (MDAs), and In-Circuit Test equipment (ICT). The Yield Management System (YMS 4.0) software can automatically collect measurement data and images, assisting production line yield and process improvement. Visit booth 1H38 (Hall 1) to discover how TRI's solutions are helping the industry meet the comprehensive range of manufacturing test and inspection requirements.

德律科技股份有限公司

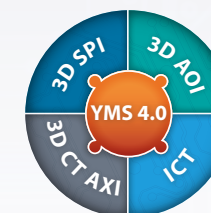
德律科技(TRI)提供完整一站式的自动检测方案以及整合性软件(YMS 4.0), 可支援工业4.0。德律科技(TRI)提供高精度及高解析的检测方案, 包含3D锡膏检测(3D SPI)、3D自动光学检测(3D AOI)、3D自动X射线检测(3D AXI), 可升级数位断层扫描功能、制造缺陷分析仪(MDA)、在线测试设备(ICT)。生产良率管理系统软件(YMS 4.0)可自动收集量测数据及影像, 协助生产线的良率及制程提升。敬请莅临1H38(1号馆)的德律科技摊位, 参观可满足业界全方位的制造测试和检验要求的解决方案。



INSPECTION for INDUSTRY 4.0

欢迎莅临体验德律全方位3D检测系统, 提供最精准及最完整的检测方案, 适合各种产业需求。

3D SPI、3D AOI、3D AXI 和高性能ICT及整合软体 YMS 4.0开启工业4.0的新世纪。



**NEPCON China 2016
2016年4月26-28日**

摊位 1H38

**TR7700Q
精准型3D AOI**



<http://www.tri.com.tw>

德律

